

<b>DECLARATION OF INVENTOR(S) FOR UNITED STATES PATENT APPLICATION</b>		ATTORNEY DOCKET NO. <b>V9661.0056</b>																																							
<p>As a below-named inventor, I hereby declare that I verily believe that I am the original, first, and sole inventor (if only one name is listed below) or a joint inventor (if plural inventors are named) of the subject matter which is claimed and for which a patent is sought on the invention entitled:</p> <p><u>NOVEL TETRAHYDROISOQUINOLINES</u></p> <p>the specification of which is attached hereto, unless the following box is checked:</p> <p><input type="checkbox"/> was filed on _____ as PCT International patent application number _____ and its U.S. national stage patent application was filed on _____ with the United States Patent and Trademark Office.</p> <p>I have read and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above. I acknowledge the duty to disclose all information known to me to be material to the patentability of the invention in accordance with Title 37, Code of Federal Regulations, §1.56.</p> <p>I hereby claim priority benefits under Title 35, United States Code §119 of any foreign application(s) for patent or inventor's certificate or United States provisional application(s) listed below and have also identified below any foreign application(s) for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:</p> <p>Prior Foreign or U.S. Provisional Application(s)</p> <table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th style="width: 25%;">COUNTRY</th> <th style="width: 25%;">APPLICATION NUMBER</th> <th style="width: 25%;">DATE OF FILING (day, month, year)</th> <th style="width: 25%;">PRIORITY CLAIMED UNDER 35 U.S.C. § 119</th> </tr> </thead> <tbody> <tr> <td> </td> <td> </td> <td> </td> <td style="text-align: center;"><input type="checkbox"/> YES <input type="checkbox"/> NO</td> </tr> </tbody> </table> <p>I hereby claim the benefit under Title 35, United States Code, §120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, §112, I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, §1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application.</p> <table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th style="width: 30%;">UNITED STATES APPLICATION NUMBER</th> <th style="width: 30%;">DATE OF FILING (day, month, year)</th> <th style="width: 40%;">STATUS (patented, pending, abandoned)</th> </tr> </thead> <tbody> <tr> <td style="text-align: center;">60/450,496</td> <td style="text-align: center;">February 27, 2004</td> <td> </td> </tr> <tr> <td> </td> <td> </td> <td> </td> </tr> <tr> <td> </td> <td> </td> <td> </td> </tr> </tbody> </table> <p>SEND CORRESPONDENCE TO: DICKSTEIN SHAPIRO MORIN &amp; OSHINSKY LLP 1177 Avenue of the Americas, 41st Floor New York, NY 10036-2714</p> <p style="text-align: right;">DIRECT TELEPHONE CALLS TO: (212) 835-1400</p> <p>I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.</p> <table border="1" style="width: 100%; border-collapse: collapse;"> <tr> <td style="width: 35%;">FULL NAME OF SOLE OR FIRST INVENTOR <b>Jun WANG</b></td> <td style="width: 35%;">INVENTOR'S SIGNATURE  </td> <td style="width: 30%;">DATE  </td> </tr> <tr> <td colspan="2">RESIDENCE (City and either State or Foreign Country) <b>Hong Kong, China</b></td> <td>COUNTRY OF CITIZENSHIP <b>China</b></td> </tr> <tr> <td colspan="3">POST OFFICE ADDRESS <b>Room 611, Graduate House, University of Hong Kong, Hong Kong, P.R. 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